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Spring 2020

Bioimpedance Sensor

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BioImpedance Sensor

Senior Project Final Report

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April 24, 2020

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Abstract (MS)

Measuring the impedance of the body is a process which can be correlated to several different aspects of the human body, more specifically, a user's hydration level. In order to find a user's impedance, first a signal must be generated and then passed through the user's body. In order to guarantee safety of the user, the signal is passed through various components, so the exact inputs are known. To send this input signal through the user's body, a set of electrodes will be used. Once the signal has passed through the user's body, it is then processed, first through a conversion of analog to digital, followed by an embedded processor, and finally sent to a wireless module via Bluetooth. Once at the wireless module, the information is sent to a server, and stored in a database. From here a user can access all previous readings and keep track of their impedance levels in the form of a mobile application.

1 - Problem Statement

1.1 – Need (SW, RB)

Many people put a great emphasis on personal health, but underestimate the importance of hydration, subjecting themselves to being either under or over-hydrated. While thirst is a strong indicator of a person's hydration level – and is sufficient for most people – consumers have no way of easily monitoring their hydration and tracking it through the day or over a longer period of time. In addition to serious medical conditions which are exacerbated by hydration levels, the symptoms of mild dehydration (e.g. headaches and muscle cramps) and the less-critical effects of overhydration (e.g. inconvenience of frequent drinking and urination) constitute a need for achieving

measured and trackable hydration feedback which many consumers would find useful[11].

1.2 – Objective (SW, KL, MS)

The best solution for the consumer would be a hydration monitor which is compact enough for home or portable use. The user's hydration level can be measured by bioelectric impedance analysis. This is done by sending a signal through the body and analyzing the changes to the output signal; these changes vary by a user's hydration level. Once the signal is measured, the data will automatically be sent to a mobile application where it will be processed and displayed to the user. The data will also be uploaded and saved for each specific user. Similar to diet and fitness applications, the user will then be able to review historic hydration (BIA) levels and better-understand how to adapt their own fluid intake. Since the fluid intake per user is different based on factors – such as limb position, recent exercise, and skin temperature – it will be important to develop a range of hydration levels that can be clearly conveyed to the user, in addition to the user's quantified bioelectric impedance.

1.3 – Background

Basic Theory Behind the Concept (MS)

Bioelectrical impedance analysis (BIA) is a safe, simple, and inexpensive technique for the evaluation of body composition. Bioelectrical impedance analysis involves electrodes being placed on different parts of the body. When placed at the hands or the feet, it is possible to measure the impedance of the body, whereas placing the electrodes at a segmented part of the body allows for a more accurate reading in that segmented area. The impedance instrument then sends a very small and harmless AC

current through a set of electrodes, and then measures how the body impedes the current flow through the set of electrodes[5].

The physical principle behind bioelectrical impedance analysis lies in the cells that are grouped up in the organs and tissues that make up the human body. Cells contain intracellular water and are bathed in extracellular water. Bioelectrical impedance analysis is based on the potential difference or voltage drop when a weak AC current is sent through the body tissues[5]. The intracellular and extracellular waters behave as electrical conductors while the cell membranes behave as imperfect reactive elements. The electrical conduction is then dependent on fluid and electrolyte distribution. The opposition to the flow of a constant alternating AC current is the impedance, which is composed of an electrical resistance that changes based on the amount of fluid in the tissue.

In order to measure this impedance, it is important to understand what variables factor into the impedance. Since impedance is the opposition to the flow of an alternating current, it is dependent on the frequency of the applied current, defined in impedance magnitude (|Z|), and phase angle (). Bioimpedance is a complex quantity which is composed of resistance (R) and reactance (X_c). The resistance is caused by total body water, and the reactance is caused by the capacitance of the cells' membrane[3]. The following equations relate the variables above.

$$Z = R + jX_c \tag{1}$$

$$|Z| = \sqrt{R^2 + X_c^2}$$
 (2)

$$\Phi = \tan^{-1}\left(\frac{X_c}{R}\right) \tag{3}$$

The resistance of an object is determined by a shape defined as length (L) and surface area (A). Material type is defined by resistivity (ρ), and reactance (X_c) of an object is defined as resistance to voltage variation across the object. The reactance is inversely related with signal frequency (f) and capacitance (C) [3]. The following equations relate the variables above.

$$R_{(\Omega)} = \rho_{(\Omega,m)} \left(\frac{L_{(m)}}{A_{(m^2)}} \right)$$
(4)

$$X_{c(\Omega)} = \frac{1}{2\pi f_{(Hz)} C_{Farad}}$$
(5)

Capacitance then is defined as the ability of a non-conducting object to save electrical charges. That is, the voltage differentiation across an object (dV/dt) and the current that is passed through the object (I(t)). In the following equations, the capacitance is directly proportional to the surface area (A), and inversely proportional to the distance (d) between the charged plates. Capacitance is also dependent on the permittivity of free space (ϵ_0) and the dielectric permittivity (ϵ_r), which is defined based on the materials between the plates.

$$C_{Farad} = \varepsilon_0 \varepsilon_r \left(\frac{A_{(m^3)}}{d_{(m)}} \right) \tag{6}$$

$$C_{Farad} = \frac{dV(t)}{dt} / I(t) \tag{7}$$

Body composition estimation using bioimpedance measurements is then based on the body volume (V_b), which can be determined through resistance measurement.

All equations above play a factor in how the impedance is measured, and as a result, they can be combined to give an accurate reading. Looking at the human body, the human body is a volume that is composed fat mass (FM) and fat free mass (FFM). Fat mass is a non-conductor of electric charge and is equal to the difference between body weight (Wt_{Body}) and fat free mass[3]. However, fat free mass is the conducting volume that passes electric current due to the conductivity of electrodes dissolved in body water. The total body water (TBW) is then the major compound of fat free mass and is equal to roughly 73.2% for normal hydration. These variables can be related together, and as a result be used to determine hydration levels.

The theory behind bioelectric impedance analysis is then that the impedance, which opposes the current flow will vary from tissue to tissue. In a statement from the Journal of Medical Engineering and Technology, "tissues containing large amounts of fluid and electrolytes have a high conductivity, and therefore a low impedance. On the contrary, fat and bones have a low conductivity, and therefore a high impedance"[5]. The bioelectric impedance analysis device then measures the impedance to the flow of the current as it passes through the body. As a result, estimates of the body composition parameters, such as hydration, can be obtained.

While the device is not expected to reach a clinical-level of accuracy for body hydration, the device might prove useful for those with chronic health issues which are treated and/or exacerbated by low or over-hydration. Chronic Kidney Disease is one example of a condition which is best-managed by maintaining a consistently-high, but not over-hydrated state. Dehydration results in frequent kidney stones which must be passed (painful) or removed surgically (expensive and risky). Overhydration causes

uncontrolled swelling of the kidneys which impinges on internal organs, nerves, and causes discomfort; for severe cases of kidney failure, overhydration is linked to increased mortality[9][10]. While an "at-home" consumer device is unlikely to be as accurate as clinical devices for measuring hydration, it could still serve as a useful tool for those with hydration-centric health risks due to the convenience of frequent non-invasive measurements. It would be necessary to avoid making any medical claims of the device – due to the possible liability concerns – but this need for a "properly-balanced" hydration level is an example of why drinking when thirsty is not always sufficient and why Users may want a convenient way to measure and track their hydration.(SW, this paragraph)

Current Uses (RB)

There are several different ways in which hydration levels are currently being measured. Shanholtzer and Patterson group these techniques into direct and indirect methods. One direct method is using radioactive isotopes to measure the amount of water in the body[1]. As the name implies, these methods directly measure body water, and therefore are more accurate. However, these techniques are usually more complex. This means they take more time and are usually less convenient, for both the user and the person doing the analysis. A direct method of measurement is not a realistic use-case for a consumer product since they require a large amount of training and human involvement. Indirect methods are less accurate than direct methods, but they are much easier to use and interpret, therefore making them better for a consumer product. One of these methods is urine analysis. As most people know, urine color is an indicator

of hydration status. However, it is not exact and can be influenced by several other factors, such as food consumed and medication[1].

Bioelectrical impedance analysis is another indirect method of measuring hydration. In a statement from the National Institutes of Health, BIA is used in many different fields, including hospitals and clinicians' offices [2]. According to Shanholtzer and Patterson, current technologies measure BIA by sending an electrical current ranging from 5 to 500 kHz through the body via electrodes[1]. It is important that a range of frequencies be used, since different frequency signals give different information about the water in the body. These authors state that a 200 kHz wave is ideal for measuring the total water in the body[1]. This is due to the reaction of the body to various frequency signals. At a low frequency, the signal is unable to pass through the membrane of cells, and therefore can measure only liquid outside of the cell. In contrast, the cell membrane cannot block high frequency signals and cellular water can be taken into account [2]. This technique is ideal for a consumer product since it requires only sensors (electrodes) to be placed on the skin and the analysis is fairly simple compared to direct methods.

Shanholtzer and Patterson also conducted a study to determine the accuracy of BIA on measuring body water and interpreting the validity of using that data to determine hydration level. In this study, impedance was measured using a Multiscan 5000 multifrequency monitor. A current of 800 microamps was send through the user's body across the target frequency range of 5 to 500 kHz. This current amplitude allows the output signal to be read accurately and with little error, but also should not be felt by the user [2]. Data was collected through the use of two electrodes on the right hand and two electrodes on the right foot. The impedance for each of these frequencies was measured,

and the 5 kHz response and the 500 kHz responses were used to determine extracellular water and total body water, respectively. The analysis of these numbers then allowed the researchers to assign the participant a hydration level.

An important aspect of bioelectrical impedance analysis is to make the datacollection and analysis as accurate as possible since there are many variables which affect results, including limb position, disease/medication, gender, skin and core temperature, single-frequency versus multi-frequency, and age.[8] (SW - this paragraph only).

Limitations of the Current Designs or Technology (KL)

Some currently available BIA technologies can measure total body water (TBW) and extracellular body water (ECW). However, they fail to draw any meaningful conclusions from this information and simply output the result as percentages to the user. Some measurements such as body fat or lean mass are useful when displayed as percentages. That is because the user is more familiar with these values and has a better intuition about what they should be. For example, the user most likely knows that their body fat percentage should be around 10-20%. However, when a user is presented with their ECW as a percentage, they probably can't interpret that information meaningfully. Especially with the minor fluctuations that occur with one's ECW.

What the current designs are missing is a way to process and interpret the water data into something more useful, such as a user's current hydration level. The bioelectrical impedance data could be used to measure a user's hydration in a couple of different ways. One method is to input a user's physical stats, such as height, weight, age, sex, and compare the total body, intracellular and extracellular water measurements to a population model. A similar method is what is currently used to measure other body stats(3). The problem with this method is that it does not account for individual variances

and just looks at the population average when making calculations. One of the advantages of measuring hydration is the ability to calibrate for each specific user. The device could have a feature that allows the user to measure once when they are in a hyperhydrated and once when they are in a hypo-hydrated state. This would give a baseline calibration that on top of the population data, could be used to improve results. This is feasible since a user can control their hydration level by drinking a lot or abstaining from drinking water before the calibration. This is different from body composition measurements, since a user cannot easily change their body tissue makeup.

Piccoli et al. proposes another method for detecting fluid changes using BIA. Their method involves breaking down the impedance into the resistance and the reactance components. Then comparing the ratios of the resistance and reactance with the person's height. They call this the RXc graph[4]. This analysis technique could also be useful for measuring hydration when combined with calibration.

Relevant Existing Patents (SW)

Patent No. US006256532B1 is an Apparatus for Analyzing Body Composition Based on Bioelectrical Impedance Analysis and Method Thereof, which is a largerformat version of the consumer-scale apparatus being proposed.[6] This patent has very similar design to a consumer-scale version and discusses the process in great detail.

Patent No. US2015/0148623A1 is a Hydration Monitoring Sensor and Method for Cell Phones, Smart Watches, Occupancy Sensors, and Wearables; this patent is relevant as it seeks to measure the same principle and addresses many of the same challenges.[7] This patent consists of a broadband LED light which is transmitted to a subject user's skin which causes scattering across various wavelengths. By analyzing the reflected light,

the patent holder describes the ability to analyze to determine various biological parameters, including hydration level. The hydration level is not based on a single measurement, but as a comparison between fluid losses, fluid ingested, fluid balance, and rate of fluid loss.

This patent utilizes a system which has some similarities with hydration monitoring performed by BIA, including non-invasiveness, difficulty of achieving a consistent method of measurement, and energy efficiency. By being a method of capturing data externally without gathering any type of respiratory, urinary, or perspiratory sample, both the photosensor and BIA methods aim to make hydration analysis more convenient for users. By being more convenient than current methods, the patent hopes to achieve a wearable scale which can be incorporated into consumer devices (e.g. fitness wearables and smart phones). Much like BIA, the photosensor analysis has the disadvantage of capturing data under uncontrolled conditions; distance from subject, perspiration, and part of the body being monitored are all stated as important factors which need to be controlled for. In the proposed "bathroom scale" design, the User's own body weight serves to ensure a reliable contact through a consistent signal path. Similar to the low-power signal generation and capture device involved in BIA, the use of a typical 3 mA LED allows for an efficient device capable of being powered by a small battery; to achieve a marketable device which is not reliant on being plugged-in to AC power, it's critical to achieve an energy efficient design.

This system also has many differences from BIA, including the source signal, the breadth of data being captured, and complicating aspect of blood flow. The photosensor patent deals strictly with generating and capturing light, whereas BIA utilizes an

electrical signal being fed through the subject. While BIA only compares to input and output signals, the photosensor patent is concerned with a wide range of data obtained by the device (e.g. including heart rate, respiratory rate, distance, and motion). Unlike with bioelectrical impedance analysis which takes the whole current path as a single medium, the photosensor patent has to control for the different light-scattering properties of hemoglobin and water. While the differences between the two technologies don't directly impact BIA, these differences inform on potential complicating factors which have to be controlled for or approximated when building a model to convert the impedance level to hydration level.

1.4 – Marketing Requirements (SW, KL, MS, RB)

- 1. Safe: Voltage and current must be low-enough to be neither felt, nor dangerous. Needs to have some sort of warning label as well.
- 2. Affordable: Expense must be kept low enough for general consumers.
- 3. Size: Device must be small enough for convenient use by holding or standing upon.
- 4. User-Friendly: App must provide user with current and historic data in an intuitive way.
- 5. Battery Life: Device must have a long life on each charge or with each set of batteries.
- 6. Accurate: Device must deliver a consistent and accurate measure of the user's Impedance level. Range of Impedance levels will need to be clear and concise, as well as have a responsive display time.

2 – Engineering Analysis

2.1 – Circuits (MS, SW)

Beginning with a generated input voltage signal, the signal will first be sent through a voltage controlled current source (VCCS). The VCCS will force the output current to be proportional to the controlled input voltage signal. An input voltage of 3V will proportionally produce an input current of 1mA. This will be achieved by using an inverting OpAmp. The purpose of the inverting OpAmp is to obtain the exact output current and voltages. By loading the feedback path back to the amplifier and grounding the noninverting terminal with a resistor back to the inverting terminal, the exact output current and voltage is known, and the excess current flows back to the feedback path. Following the inverting OpAmp are two sets of differential amplifiers, which act as buffers, having two inputs, two copies of the same signal that are opposite in phase are sent through the amplifier. Any noise that is induced will be equal and opposite and thus canceling out. This way the generated input signal will be equal to the output, and the voltage gain will be known. Following the differential amplifier will be an inverting amplifier. To keep the circuit safe, the signal must stay below the pain threshold, which is well-below the AC let-go current of 5mA for children; DC let-go current is greater than 60 mA[12][13]. Due to the wide range of human body resistance[14], it is important to limit the signal voltage to keep the signal in a low-voltage range (below 30V).

The system power supply consists of three DC voltage outputs: +9V and $\pm 18V$. All three voltages are achieved through the use of standard 9 Volt DC alkaline batteries to reduce cost and make replacements user-friendly. $\pm 18V$ are each achieved by wiring two batteries in series. Each battery has approximately 500mAh capacity. The limiting

factor for system power is the 9V circuit feeding the Explorer-16/32 board, which has an approximate current load of 200mA while the system is ON. With an expected uptime not to exceed 10seconds per measurement cycle, each measurement draws 0.56mAh making the expected battery life is at least 900measurements. With typical usage expected to be three measurements per day, the real-time battery life is at least 300days. Since the $\pm 18V$ circuits are powering OpAmps drawing less than 1mA, the series batteries will last for years and likely need replaced only due to degradation from age.

2.2 – Electronics (MS)

An electrode is a conductor through which current enters or leaves an object, in this case the human body. The human body acts as a medium in which the transmitter and receiver make contact between the skin and the electrodes. Two electrodes will be used, one to pass the input current - the other for the input voltage - through the user (transmitter), and then pass the output current - or voltage - to the embedded processor (receiver).

2.3 – Signal Processing (KL)

Measuring the bio-impedance will involve applying a voltage to the body and . To accomplish this, a periodic square wave will be generated and sent through the body. A square wave was chosen because it will be much easier to generate as opposed to a sine wave.

Once the square wave is sent through the body, the current going through the body and the voltage applied across the body will need to be sampled. This will be done by connecting op-amp circuits at the input and output to the AD converter. The sampling

rate will need to be greater than the square wave frequency in order to get an accurate result.

After the points are sampled, the signal will be converted into the frequency domain using the Discrete Fourier Transform. Once in the frequency domain, the magnitude and phase of the first harmonic sine wave will be able to be analyzed, for the voltage and current. From here, the phasor voltage and current can be realized. Finally, the impedance can be calculated by dividing the phasor voltage by the phasor current.

To demonstrate this process, in MATLAB we simulated placing a square voltage wave across an RC circuit and calculated the current at discrete samples. We then wrote code to perform the steps mentioned above to calculate the impedance. The calculated impedance was then compared with the expected impedance of the RC circuit.



Figure-1: Impedance Calculation Error

Figure 1 shows the error in calculating the impedance using the square wave technique with varying number of sample points per period. The results were an error of around 3% in the magnitude and phase when 20 samples points were used, and less than 1% when 50 samples points were used. This shows that we will be able to calculate the impedance to a reasonable degree of accuracy by using a square wave and the discrete Fourier analysis. This also suggests that our target range for sampling speed should be somewhere between 20 and 100 samples per period in order to get an accurate result.

MATLAB code for error simulation:

```
num steps = 50;
start = 1;
offset = start-1;
step = start:num steps;
mag err = zeros(1, num steps-offset);
phase err = zeros(1, num steps-offset);
mag err sin = zeros(1, num steps-offset);
phase err sin = zeros(1, num steps-offset);
for index = step
    N = 2 \times index;
    Vs = 1;
    R = 1.5e3;
    C = .1e-9;
    T = 2e-6;
    f = 1/T;
    w = 2*pi*f;
    k = 1;
    Z = R + 1/(1j*k*w*C);
    v n = zeros(1, N-1);
    i_n = zeros(1, N-1);
    for n = 1:N
        if n < N/2
           v n(n) = 1;
           i n(n) = (Vs * exp(-((n/N)*T)/(R*C))) / R;
        else
           v n(n) = 0;
           i n(n) = -(Vs * exp(-(((n - N/2)/N)*T)/(R*C))) / R;
        end
```

```
vn sin = zeros(1, N-1);
    in sin = zeros(1, N-1);
    for n = 1:N
        t = (n/N) *T;
        vn sin(n) = sin(w*t);
        I = 1/Z actual;
        in sin(n) = abs(I) * sin(w*t + angle(I));
    end
   V fft = fft(v n);
    I fft = fft(i n);
   V k = 0;
    for n = 0:N-1
        V = V + v n(n+1) \exp(-1j \cdot 2 \cdot pi \cdot k \cdot n/N);
    end
    I k = 0;
    for n = 0:N-1
       I k = I k + i n(n+1) * exp(-1j*2*pi*k*n/N);
    end
    Z exp = V k / I k;
   mag err(index-offset) = (abs(Z exp)-abs(Z actual))/abs(Z actual);
    phase err(index-offset) = (angle(Z exp)-
angle(Z actual))/angle(Z actual);
    V k sin = 0;
    for n = 0:N-1
        V k sin = V k sin + vn sin(n+1) * exp(-1j*2*pi*k*n/N);
    end
    I k sin = 0;
    for n = 0:N-1
       I k sin = I k sin + in sin(n+1)*exp(-1j*2*pi*k*n/N);
    end
    Z exp sin = V k sin / I k sin;
   mag err sin(index-offset) = (abs(Z exp sin)-
abs(Z actual))/abs(Z actual);
    phase err sin(index-offset) = (angle(Z exp sin) -
angle(Z actual))/angle(Z actual);
end
```

2.4 – Embedded Systems (RB)

end

For our embedded controller, we are looking at using the Explorer 16/32

Development with the dsPIC33FJ256GP710 General Purpose PIM as our processor. The

given PIC24FJ1024GB610 PIM could not simultaneously sample two channels, so we could no longer use it.

One of the biggest roles our embedded system will play is doing the A/D conversion. We will be sampling waveforms of various frequencies, with a maximum of 50 kHz. According to the data sheet listed in the Appendix, the dsPIC33FJ256GP710 can perform at a rate of 1.1 Msps, or 1,100,000 samples per second, which should be fast enough for our needs. This allows for around 20 samples at our highest frequency, which will keep our error under 5%. Our A/D converter will also need to potentially handle multiple channels so we can sample multiple waveforms simultaneously. The data sheet reports that the dsPIC33FJ256GP710 can handle "simultaneous sampling of up to four analog input pins". We will only need two of those. The data sheet covers the A/D converter in detail in section 21.0.

Another key functionality we require of our embedded system is being able to display our readings for the users' purpose. The Explorer 16/32 board makes this simple using its "2-Line by 16-Character LCD Module" as described by the User's Guide shown in the appendix. The dsPIC33FJ256GP710 chip can communicate with the LCD by controlling the signals of the Truly TSB1G7000-E. We will also need the embedded system to be able to wireless communicate. Along with a separate chip, the dsPIC33FJ256GP710 can use UART to communicate with a mobile phone, which will run our application.

All of these features, along with processing to do calculations, can be done with these components and the MPLAB software.

Table 1 – Engineering Requirements		
Marketing Engineering Requirements Justification		
Requirements		
1	Generate & measure accurate	Must be safe for all users.
	Voltage across Body (1V –	Keeping voltage within OpAmp
	18V) ±10%	rails will maintain safe power
		levels.
1	Generate & measure accurate	Must be safe under all conditions.
	signal Current of 1mA ±10%	Current not to exceed 5mA.
6	Impedance Magnitude & Phase	To be consistent and repeatable,
	measurement & calculation	Impedance data points must have
	precision within 5% (data	little variance.
	points in tight cluster)	
6	Impedance Magnitude & Phase	To be useful, Impedance must be
	measurements & calculation	found to be close to known value.
	accuracy within 10%	
6	Frequency Steps of:	Low-frequency for extra-cellular
	50Hz, 500Hz, 5kHz, 50kHz	resistance, high-frequency for
		intra-cellular capacitance
4, 6	Wireless range of up to 10m	User will be close to device; low
		power saves on battery life.
4, 6	Remote Data Storage &	Impedance calculation can be
	Retrieval	done locally, but hydration model
		and historic data requires database
		interaction.
3, 5	System will be portable with an	Batteries allow compact, portable
	energy storage life of 6months	device with long life.
6	AC Signal analysis will be used	Board limitations and to ease
	to calculate Impedance	magnitude and phase calculations
	Magnitude & Phase	
4	Impedance Magnitude & Phase	Must show users impedance in a
	Display at device & App	user-friendly manner.

3 – Engineering Requirements Specification (SW, RB, MS)

Marketing Requirements:

1. Safe: Voltage and current must be low-enough to be neither felt, nor dangerous. Needs to have some sort of warning label as well.

2. Affordable: Expense must be kept low enough for general consumers.

3. Size: Device must be small enough for convenient use by holding or standing upon.

4. User-Friendly: App must provide user with current and historic data in an intuitive way.

5. Battery Life: Device must have a long life on each charge or with each set of batteries.

6. Accurate: Device must deliver a consistent and accurate measure of the user's Impedance level. Range of Impedance levels will need to be clear and concise, as well as have a responsive display time.

4– Engineering Standards Specifications (MS)

Table 2 – Engineering Standards			
Specification Standard Use			
Safety	NIOSH	Bodies reaction for	
	NEC	different currents (~1mA	
		desired).	
Communications	USB & Bluetooth	USB to program the board	
		and Bluetooth to send data	
		to the mobile application.	
Data Formats	Decimals	Magnitude & Phase.	
Design Methods	LTSpice	Circuit design &	
		simulation.	
Programming Languages	Embedded – C	C to program the	
	App – JavaScript, Dart,	embedded processor,	
	SQL	JavaScript (Node.js) for	
		AWS Lambda functions,	
		Dart for mobile app and	
		SQL for Postgres database	
Connector Standards	USB	Program and debug board.	

5- Accepted Technical Design

Block Diagram Level 0 (SW, RB, KL)



Figure-2: Block Diagram Level 0

5.1 – Hardware Design – Level 1 (SW)



Figure-3: Hardware Block Diagram Level 1

Table 3.1 – Functional Requirements: Voltage-Controlled Current Source		
Module	Voltage Controlled Current Source	
Designers	Mitchell Sutyak & Steve Weimer	
Inputs	Generated input voltage signal	
Outputs	Specified input current signal	
Description	Current produced in accordance with sign and magnitude of controlled	
	input voltage	

Table 3.2 – Functional Requirements: Differential Amplifiers		
Module	Differential Amplifiers	
Designers	Mitchell Sutyak & Steve Weimer	
Inputs	Voltages from Sense Resistor & Across Body	
Outputs	Input current and measurement voltage	
Description	Differential gain control	

Table 3.3 – Functional Requirements: Inverting Operational Amplifier		
Module	Inverting Operational Amplifier	
Designers	Mitchell Sutyak & Steve Weimer	
Inputs	Digital Square-Wave from Embedded Processor	
Outputs	Inverting Output to Inverting Terminal, based on Feedback Impedance	
Description	Maintains Current at desired level across Feedback Impedance (Body)	

Table 3.4 – Functional Requirements: Electrodes	
Module	Electrodes
Designers	Mitchell Sutyak
Inputs	Exact input current
Outputs	Output current signal
Description	Connection between the device and the user

Hardware Level 1 Block Diagram (MS)

The circuit design shows the major components needed. Once the input signal has been generated, it will need to pass through a series of components in order to be safely sent through the user via two electrodes. The first component is a voltage controlled current source, followed by a differential amplifier, an inverting amplifier and finally sent through the electrodes. The purpose of these components is to first specify the current being sent through the circuit based off a controlled voltage input. Next, to account for any noise and voltage gain, a differential amplifier is used to buffer or clean the signal. The purpose of the inverting amplifier will be to know the exact current that will be sent into the electrodes. An input current of 1mA will be injected into the body. The voltage is a product of the input current and the body resistance, which has a wide potential range. When the human body is perfectly dry and calluses have formed on the skin, the resistance of the external body can be as high as $1M\Omega$, however, this is not a realistic resistance for the average user. Considering all factors that can reduce a user's external resistance, a realistic level of resistance for a user can be as low as 300Ω . Using this as our baseline, the 1V and 1mA values are expected to be safe for each user. The inverting amplifier will then send any excess current back into the feedback path of the amplifier, and finally sent through the electrodes. The electrodes will have two components, the transmitting component and the receiving component. After the signal has traveled through the user's body, it will then be sent to the embedded processor where A/D conversion will take place.



5.2 – Hardware Design – Level 2 (MS)

Figure-4: LTSpice Schematic with RC Ladder Network (SW)







Figure-6: LTSpice Simulated Voltage and Current with Frequency at 50 Hz



Figure-9: LTSpice Simulated Voltage and Current with Frequency at 50000 Hz

The spice simulations were the building blocks of the hardware design. Once we had a general idea of how the circuit was to be built, we then applied that knowledge to the LTSpice software in order to simulate the circuit. The resulting simulation waveforms above show the voltage and the current at each frequency. At each range of frequency, we were able to maintain a steady current right around 1mA which was the goal of the design as well as not to exceed the rail voltage of 10V. What we learned from these simulations are that the voltage rails are independent of the frequency. Setting an expected resistance of the body at 2-10k, we would push the voltage rails consistently, however, we maintained a steady current of 1mA. Comparing these results with the RC ladder network, we saw results were very similar. A major difference was that the time required to reach Steady-State was large, approximately 30ms or 1500 periods.



Figure-10: Preliminary Breadboarded Circuit

When designing the circuit on the board, we first started by using a Tektronix AFG3021B Signal/Function Generator, an Agilent Technologies MSO6012A Mixed Signal Oscilloscope and an Agilent #3631A Triple Output DC Power Supply. With the function generator, we were able to set up our 0V - 1V square wave and then vary the frequency from 50Hz - 50000 Hz. With the power supply, we were able to supply each rail of the operational amplifier with +/- 10V. Finally, with the oscilloscope, we were able to measure the voltage and current at different points in the circuit. The end design will include a battery supply consisting of two 9V batteries in series to replace the power supply.



Figure-11: Oscilloscope Measurement at 50 Hz



Figure-12: Oscilloscope Measurement at 500 Hz



Figure-13: Oscilloscope Measurement at 5000 Hz



Figure-14: Oscilloscope Measurement at 50000 Hz

The resulting oscilloscope readings show the voltage differentials at each range of frequency. Maintaining a current of just below 1mA over each frequency, the voltage at

each frequency peaked at just under 2V. This differed from the LTSpice simulations as we had reached the rails consistently. Also, in LTSpice at frequencies of 5000Hz and 50000Hz we saw voltage waveforms that only peaked slightly whereas at the same frequencies on the board we saw increased peak durations that more resembled the square wave input. The probable reason for this is due to simulation in LTSpice with a LT1079, and then using a UA741 on the board for the inverting operational amplifier.

5.1.1 – Circuit Construction (SW)

Throughout the project, many different OpAmps were tried in the Inverting, Differential, and Buffer stages, with mixed results. Figure-15 illustrates the difficulties found when using a slow OpAmp like the UA741; the low slew-rate of 500mV/µs was unable to achieve a proper square-wave which drastically affected results at high resistances and low frequencies.



Figure-15: Inverting UA741 at 50Hz

In an effort to remedy the slew-rate issue, the UA741 was replaced with an LM318 which has a slew-rate of $50V/\mu s$. Figures-16,17 show that – while the change fixed the slew rate issue – it introduced a considerable amount of noise, rendering the data useless. Both figures reflect the circuit buffer OpAmps in the differential stage.



Figure-16: Inverting LM318 at 50Hz (with Buffers)



Figure-17: Inverting LM318 at 50kHz (with Buffers)

Figures-18,19 show the same circuit with the buffers removed, demonstrating that the buffers were exacerbating the noise issue and needed to be addressed.



Figure-18: Inverting LM318 at 50Hz (without Buffers)



Figure-19: Inverting LM318 at 50kHz (without Buffers)
After performing the necessary voltage-attenuation to get within the embedded board's voltage range (below 3.3V), the noise – even without buffers – was still too significant to yield useful data. Figures-20,21 show the inverting output signal and the attenuated signal at the differential output.



Figure-20: Inverting LM318 at 50Hz (Attenuated)



Figure-21: Inverting LM318 at 50kHz (Attenuated)

Figures-22,23 show the same circuit as above, but with a low-noise TLE2142 used in lieu of the previous LM318 Inverting OpAmp. These waveforms show the desired results, an attenuated circuit with neither slew-rate or noise issues. This demonstrates how important it was for the circuit to use high slew-rate, low-noise OpAmps.



Figure-22: Inverting TLE2142 at 50Hz (Attenuated)



Figure-23: Inverting LM318 at 50kHz (Attenuated)

Since the same signal is passed through the buffer and differential stages, all were replaced with TLE2142 OpAmps to keep the data as useful as possible. Although this solved the Voltage Differential measurement noise, the Current Differential measurement was still noisy due to its low voltage level of 1V. To remedy this, the sense resistor Rm was increased from 10Ω to $1k\Omega$, which drastically-increased the signal-to-noise-ratio. Preliminary integration between the breadboarded circuit and embedded processor's sampling and calculations validated the circuit; impedance measurements were within 10% of expected values.

5.1.2 – Bench Setup (MS)

The following figures show the preliminary integration setup between the breadboarded circuit and the embedded processor, as well as the hardware setup including the power supplies used to power the TLE2142 op amps.



Figure-24: Breadboard Layout Without Buffers



Figure-25: Embedded Processor Layout



Figure-26: Hardware and Software Integration



Figure-27: Bench Setup with Hardware and Software Integration

As stated above, removing the buffers was an act directed towards reducing all noise generated throughout the circuit. The theory was that once the components were soldered into the protoboard, most of, if not all noise generated would be removed and the buffers could be added back into the circuit. At this point in time, the hardware side was getting usable data which could be sent to the embedded processor, and thus integration between hardware and software could be introduced. Using a square wave generated from the embedded processor, data was sent to the embedded processor and impedance values were then calculated. The final design would have replaced the power supplies used with 9V batteries connected in series, and with the desired outputs from the circuit, the oscilloscopes would no longer need to be used. Although only early stages of integration were performed, data collected on the software end matched the waveforms obtained through simulation on the hardware end. As a result, impedance calculations were then able to be carried out and analyzed.



5.2 – Software Design (RB)

Figure-28: Embedded System Block Diagram Level 1

Table 4.1 – Functional Requirements: Analog/Digital Converter			
Module	A/D Converter		
Designers	Ryan Byo		
Inputs	Measured Vout and Iout		
Outputs	Sampled Vout and Iout		
Description	Sample the voltage and current waveform to later be processed		

Table 4.2 – Functional Requirements: Embedded Processor			
Module	Embedded Processor		
Designers	Ryan Byo		
Inputs	Sampled Vout and Iout		
Outputs	Impedance Value		
Description	Use the sampled values to calculate the impedance. Also, generate		
	control signals when needed		

	Table 4.3 – Functional Requirements: Wireless Module
Module	Wireless Module
Designers	Ryan Byo
Inputs	Impedance Value, Time, Data
Outputs	Data package of inputs
Description	Transmit data to the mobile app/server

The embedded controller will be running code to do several different things. The below chart shows the control and data flow. The A/D converter, along with the DMA, direct memory access, unit, will need setup and then readings can begin. After the reading is done, we want to store that value as quickly as possible so the next sample can be taken. We will have to sample many times, so that process will repeat until we have all the data we need. Readings will continue to be taken until we have sufficient samples, and then the DMA buffer will be accessed, and the sampled values are read. Then, processing power will calculate the impedance so it can be displayed on board and sent away to be used by the app.



Figure-29: Embedded System Flow Chart (RB)

Subsystem Code (RB, KL)

A/D Converter, DMA, and LCD:

```
// Define Message Buffer Length for ECAN1/ECAN2
#define MAX_CHNUM 3 // Highest Analog input number in Channel Scan
#define SAMP_BUFF_SIZE 128 // Size of the input buffer per analog input
#define NUM_CHS2SCAN 2 // Number of (input pins) channels enabled for channel scan
#define SAMP_FREQUENCY 500000
#define MAX_SAMPLES_PER_PERIOD SAMP_FREQUENCY / 50
// Align the buffer to 512 bytes. This is needed for peripheral indirect mode
int BufferA[MAX_CHNUM + 1][SAMP_BUFF_SIZE] __attribute_((space(dma), aligned(1024)));
int BufferB[MAX_CHNUM + 1][SAMP_BUFF_SIZE] __attribute_((space(dma), aligned(1024)));
```

Figure-30: Useful Constants

We define a couple useful constants at the top of the file that will be used

throughout the program.

```
19 struct Impedance
20 {
21 | float real;
22 | float imag;
23 };
```

Figure-31: Impedance Struct

The impedance struct provides a convenient way of storing the results of the

impedance calculation. It consists of two floating point values, one for the real part and

one for the imaginary part of the impedance.

```
62 void ms_delay(int N)
63 {
   unsigned int delay = N; // N ms delay
    int i;
     int numLoops = N / 399;
    for (i = 0; i <= numLoops; ++i) {</pre>
       TMR1 = 0; // reset TMR1
70
       int tmr1Delay = delay % 399;
       if (i < numLoops) {</pre>
          tmr1Delay = 399;
        }
74
      tmr1Delay *= 164;
       while (TMR1 < tmr1Delay); // wait for delay time</pre>
78
    }
79 }
```

Figure-32: msDelay Function

This function is used to implement a millisecond delay in our code. During that time, the code is running NOPs. It is used throughout the code to allow initialization to occur, along with waiting an appropriate amount of time for data to be sent.

```
81 void initClockPLL()
82 {
83  // via the header.h file, the system is set to Primary Oscillator (XT) w/ PLL
84  // the crystal has a speed of 8 MHz and the system has a max speed of 40 MHz
85  // we will run the board at 40 MHz using PLL
86
87  CLKDIVbits.PLLPOST = 0; //Set the postscaler N2 = 2
88  CLKDIVbits.PLLPRE = 0; //Set the prescaler N1 = 2
89  PLLFBDbits.PLLDIV = 40; //Set the multipler M = 40;
90
91  //This gives us Fosc = Fin*M/(N1*N2) = 8*40/(2*2) = 80 MHz
92  //Then Fcy = Fosc/2 = 40 Mhz
93 }
```

Figure-33: A Function to Setup the Embedded Clock Speed

This function modifies the PLL (phase-lock loop) module. The PPL allows us to modify the base clock speed of our processor to a custom value. In our case, we bumped our 8 MHz clock to run at 40 MHz, which is the fastest it can run, which is ideal for fast

sampling.

```
void initADC()
{
 AD1CON1bits.ADDMABM = 0; // DMA buffers are built in scatter/gather mode
  AD1CON1bits.FORM = 0; // Data Output Format: unsigned integer (0-1023)
  AD1CON1bits.SSRC = 2;
                          // Sample Clock Source: GP Timer starts conversion
  AD1CON1bits.ASAM = 1;
                          // ADC Sample Control: Sampling begins immediately after conversion
  AD1CON1bits.AD12B = 0;
                          // 10-bit ADC operation
  AD1CON1bits.SIMSAM = 1; // sample simultaneously
  AD1CON2bits.CSCNA = 1; // Scan Input Selections for CH0+ during Sample A bit
  AD1CON2bits.CHPS = 1; // Converts CH0 and CH1
  AD1CON2bits.SMPI = 0; // 2 ADC Channel is scanned
  AD1CON3bits.ADRC = 0; // ADC Clock is derived from Systems Clock
  AD1CON3bits.ADCS = 1; // ADC Conversion Clock Tad=Tcy*(ADCS+1)= (1/40M)*2
                        // ADC Conversion Time for 10-bit Tc=12*Tab
  AD1CON3bits.SAMC = 1;
  AD1CON4bits.DMABL = 7; // Each buffer contains 128 words
 //AD1CSSH/AD1CSSL: A/D Input Scan Selection Register
 AD1CSSH = 0 \times 0000;
  AD1CSSLbits.CSS0 = 1; // Enable AN0 for channel scan
  AD1CSSLbits.CSS3 = 1; // Enable AN3 for channel scan
```

Figure-34: Part 1 of Code to Initialize the ADC

```
//AD1CHS0: A/D Input Select Register
       AD1CHS0bits.CH0SA = 0; // MUXA +ve input selection (AIN0) for CH0
       AD1CHS0bits.CH0NA = 0; // MUXA -ve input selection (VREF-) for CH0
       //AD1CHS123: A/D Input Select Register
       AD1CHS123bits.CH123SA = 1; // MUXA +ve input selection (AIN3) for CH1
128
       AD1CHS123bits.CH123NA = 0; // MUXA -ve input selection (VREF-) for CH1
       //AD1PCFGH/AD1PCFGL: Port Configuration Register
       AD1PCFGH = 0xFFFF;
       AD1PCFGL = 0xFFFF;
       AD1PCFGLbits.PCFG0 = 0; // AN0 is analog
134
       AD1PCFGLbits.PCFG3 = 0; // AN3 is analog
       IFSObits.AD1IF = 0; // Clear the A/D interrupt flag bit
       IECObits.AD1IE = 0; // Do Not Enable A/D interrupt
       AD1CON1bits.ADON = 1; // Turn on AD
140 }
```

Figure-35: Part 2 of Code to Initialize the ADC

This function configures the ADC module of the dsPIC33. Here, we set the configuration registers and setup the channels we will use. The important configuration set is we are using 10-bit mode, using CH0 and CH1, and using the DMA buffer (from the beginning index) to store the data and an interrupt triggers the end of the sampling. We also configure AN0 and AN3 pins as analog so we can use those as our input pins.

```
154 void initDMA()
155 {
156 DMA@CONbits.AMODE = 2; // Configure DMA for Peripheral indirect mode
157 DMA@CONbits.MODE = 2; // continuous ping pong
158 DMA@PAD = (int)&ADC1BUF@;
159 DMA@CNT = (SAMP_BUFF_SIZE * NUM_CHS2SCAN) - 1;
160 DMA@REQ = 13; // Select ADC1 as DMA Request source
161
162 DMA@STA = __builtin_dmaoffset(BufferA);
163 DMA@STB = __builtin_dmaoffset(BufferB);
164
165 IFS@bits.DMA@IF = 0; //Clear the DMA interrupt flag bit
166 IEC@bits.DMA@IE = 1; //Set the DMA interrupt enable bit
167 }
```

Figure-36: Code to Initialize DMA

This function configures the DMA unit of the dsPIC33. We setup the DMA to use Channel 1 in continuous mode, meaning that the DMA will continue to be active the whole time we write to it, and disable ping-pong since we will only be writing to one buffer. We also tell the DMA that its samples will be coming from the ADC. Finally, we enable the DMA interrupt to tell us when sampling is done, and we can calculate a value.

```
142 void startSamp()
143 {
144   AD1CON1bits.SAMP = 1; // start sampling
145   DMA@CONbits.CHEN = 1; // Enable DMA
146 }
147
148 void stopSamp()
149 {
150   AD1CON1bits.SAMP = 0; // stop sampling
151   DMA@CONbits.CHEN = 0; // disable DMA
152 }
Figure-37: Start and Stop Sampling
```

rigure-57: Start and Stop Sampling

These two functions allow us to start and stop the sampling of our input signals by

turning the ADC off and disabling the DMA.

```
169 void initTimer3(double frequency)
170 {
171  TMR3 = 0x0000;
172
173  double scale = 2.0;
174  PR3 = (1.0 / frequency) / (scale * (1.0 / FCY));
175
176  IFS0bits.T3IF = 0; // Clear Timer 3 interrupt
177  IEC0bits.T3IE = 0; // Disable Timer 3 interrupt
178  T3CONbits.TON = 1; // Turn Timer 3 on
179 }
```

Figure-38: Initialization of Timer 3

This function initializes timer 3 to run at the desired frequency. This will ultimately be used to time the ADC and DMA controllers to sample at the desired speed. It also disables the timer interrupts because they will not be needed.

```
void __attribute__((interrupt, no_auto_psv)) _DMA0Interrupt(void)
234 {
     int bufferOffset = dmaInterruptCount * SAMP BUFF SIZE;
     int i;
      if (pingPongState == 0)
238
     {
       for (i = 0; i < SAMP_BUFF_SIZE; ++i)</pre>
       {
           vn[bufferOffset + i] = BufferA[0][i];
           in[bufferOffset + i] = BufferA[3][i];
       }
       }
       else
       {
      for (i = 0; i < SAMP_BUFF_SIZE; ++i)</pre>
       {
           vn[bufferOffset + i] = BufferB[0][i];
           in[bufferOffset + i] = BufferB[3][i];
       }
       }
     pingPongState ^= 1;
     dmaInterruptCount++; // increment DMA interrupt counter
     IFSObits.DMAOIF = 0; // Clear the DMAO Interrupt Flag
259 }
```

Figure-39: DMA Interrupt Controller

The DMA interrupt function is where the raw data from the AD conversion gets processed. This function is set to trigger after 64 samples on each channel have been taken. The samples are then converted from 10bit integers to floating point values representing the actual voltage that was read. The converted values are then stored in temporary buffers and passed to the "calculateImpedance" function shown in figure-41. Finally, the last step is to clear the DMF interrupt flag to prevent the interrupt from immediately being trigger again.

```
181 void initPWM(double frequency)
182 {
      T2CON = 0 \times 0000;
184
      PR2 = ((FCY / frequency) - 1) / 2; // divide by 2 since we need 2 toggles for a full period
     OC1CONbits.OCSIDL = 0;
     OC1CONbits.OCFLT = 0; // PWM fault detection, not used unless OCM=0b111
188 OC1CONbits.OCTSEL = 0; // use timer 2
189 OC1CONbits.OCM = 3; // toggle mode, i.e. square wave
191 OC1R = 0;
193 T2CONbits.TON = 1; // turn timer 2 on
194 }
196 void stopPWM()
197 {
     T2CONbits.TON = 0; // turn timer 2 off
199 }
                       Figure-40: Initialize the PWM Module
```

This function sets the OC1 module to create a periodic square wave at the value of the passed in frequency. This will be the input signal that ultimately gets applied over the body.

```
266 struct Impedance calcImpedance(int N)
267 {
268 double vReal = 0.0;
269 double vImag = 0.0;
270 double iReal = 0.0;
271 double iImag = 0.0;
    double k = 1.0;
      int n;
      for (n = 0; n < N; ++n)
      {
        double t = 2 * M_PI * k * ((double)n / N);
        double v = convertSample(vn[n]) * 3.3;
         double i = convertSample(in[n]) / 1000.0;
         vReal += v * cos(t);
         vImag += v * -1 * sin(t);
       iReal += i * cos(t);
       iImag += i * -1 * sin(t);
       }
      struct Impedance imp;
    double mag = sqrt(pow(vReal, 2.0) + pow(vImag, 2.0)) / sqrt(pow(iReal, 2.0) + pow(iImag, 2.0));
      double phase = atan(vImag / vReal) - atan(iImag / iReal);
293 imp.real = mag * cos(phase);
    imp.imag = mag * sin(phase);
296 return imp;
297 }
```

Figure-41: Impedance Calculation

This function calculates the impedance of the voltage and current array that are passed as arguments. The function uses the discrete Fourier transform to find the phasor current and voltage at the sample frequency. The magnitude and phase of the impedance are calculated from the voltage and current samples. The function then converts the magnitude and phase into a real and imaginary form, where it is then returned as a struct.

LCD Control:

```
9
       For Explorer 16 board, here are the data and control signal definitions
10
      RS -≻ RB15
11
      E -> RD4
12
      RW -> RD5
13
      DATA -> REØ - RE7
14
     */
15
16
    // Control signal data pins
17
    #define RW LATDbits.LATD5 // LCD R/W signal
#define RS LATBbits.LATB15 // LCD RS signal
18
19
    #define E LATDbits.LATD4 // LCD E signal
20
21
   // Control signal pin direction
22
    #define RW TRIS TRISDbits.TRISD5
23
   #define RS TRIS TRISBbits.TRISB15
24
25
    #define E TRIS TRISDbits.TRISD4
26
    // Data signals and pin direction
27
    #define DATA LATE // Port for LCD data
28
    #define DATAPORT PORTE
29
                                     // I/O setup for data Port
30
    #define TRISDATA TRISE
                        Figure-42: LCD Control Pins
```

This code defines our control signals of the LCD. According to the Explorer

16/32 User Guide, the RS bit, which selects the register to either accept data or a command, is tied to RB15. The RW bit, which controls the read/write process, is tied to RD5. The enable bit is tied to RD4. The data pins are on the eight pins of E.

```
void measureImpedance()
401
     {
       unsigned int freqs[3] = {50, 500, 5000, 50000};
       int i;
       struct Impedance impResults[4];
       unsigned char impedanceStr[19];
        for (i = 0; i < sizeof(freqs) / sizeof(freqs[0]); ++i)</pre>
        {
         clearDisplay();
         ms_delay(100);
         cursorHome();
413
         ms_delay(100);
         sprintf(impedanceStr, "Measure %uHz", freqs[i]);
         puts_lcd(impedanceStr, 13 + i);
         ms_delay(3000);
417
         initPWM(freqs[i]);
          ms_delay(500); // wait 0.5s to reach steady state
          int numSamples = SAMP_FREQUENCY / freqs[i];
          int numInterrupts = numSamples / SAMP_BUFF_SIZE;
          // account for integer division truncation
          if (numInterrupts == 0 || numSamples % SAMP_BUFF_SIZE != 0)
          {
            numInterrupts++;
          }
          startSamp();
432
          dmaInterruptCount = 0;
         while (dmaInterruptCount < numInterrupts);</pre>
          stopSamp();
          stopPWM();
438
          impResults[i] = calcImpedance(numSamples);
         clearDisplay();
         cursorHome();
         ms_delay(100);
         sprintf(impedanceStr, "Re. %+.2e", impResults[i].real);
         puts_lcd(impedanceStr, 13);
         bottomLine();
         sprintf(impedanceStr, "Im. %+.2e",impResults[i].imag);
446
         puts_lcd(impedanceStr, 13);
         ms delay(5000);
        }
       // send final results over bluetooth
451
452
     }
```

Figure-43: Measure Impedance

This function orchestrates all the different subsystems to measure the impedance of the given load. It first defines the 4 different frequency ranges that will be measured, which are 50, 500, 5k and 50k Hz. For each frequency range, a message is output to the LCD telling the user which range is being currently measured. A square wave at the given frequency is output and AD samples are taken for both the input voltage across the body and the current going through the body. The sample rate is kept constant and is set to the max rate that could be safely achieved using two simultaneous channels. The number of samples used to make the impedance calculation is determined by the current input frequency. After the impedance is calculated, it is displayed on the LCD and sent over Bluetooth to the mobile device.

```
void lcd cmd( char cmd )
                              // subroutiune for lcd commands
 96
 97 🗏 {
 98
         DATA &= 0xFF00;
                                    // prepare RD0 - RD7
 99
         DATA |= cmd;
                                     // command byte to lcd
         RW = 0;
                                     // ensure RW is 0
100
         RS = ∅;
101
102
         E = 1;
                                       // toggle E line
103
         ms delay(50);
104
         //NOP
105
         E = 0;
         ms_delay(5); // 5ms delay
106
107
      }
108
109
110
     void lcd data( char data ) // subroutine for lcd data
111 🖂 {
                                    // ensure RW is 0
         RW = ∅;
112
         RS = 1;
                                    // assert register select to 1
113
         DATA &= 0xFF00;
                                     // prepare RD0 - RD7
114
115
         DATA |= data;
                                     // data byte to lcd
         E = 1;
116
         ms delay(50);
117
         //NOP
118
119
         E = 0;
                                     // toggle E signal
                                     // negate register select to 0
120
         RS = ∅;
         ms_delay(1000); // 1mS delay
121
122
      }
```



This code allows us to write both commands and data to the LCD by setting the appropriate RS bit, enabling the line to send the information, and then delaying while the LCD is processing the data.

```
void puts lcd( unsigned char *data, unsigned char count )
124
125
      {
          while ( count )
126
127
          {
              lcd data( *data++ );
128
              count --;
129
130
          }
131
      }
```

Figure-45: Write String to LCD Methods

This function using the above lcd_data method to write a string to the LCD by

repeatedly calling the subroutine for each character.

```
int main(void)
    {
      initClockPLL();
       T1CON = 0 \times 8030;
        T1CONbits.TCKPS = 3; // prescale period of 256
        T1CONbits.TON = 1; // Turn Timer 1 on
       initADC();
       initDMA();
        initTimer3(SAMP_FREQUENCY);
        Init_LCD();
       measureImpedance();
       while (1)
        {
        // cursorHome();
471
         // ms_delay(1000);
472
         // puts_lcd("Imped = 10", 10);
473
         // ms delay(1000);
474
         // clearDisplay();
          // ms_delay(1000);
       }
477
       return 0;
478
479 }
```

Figure-46: Main Method

This function is what runs when the program starts. It begins by initializing all the needed modules, including PLL, Timers 1 and 3, ADC, DMA, and LCD. It then runs the measureImpedance() procedure to sample, convert, calculate, and display our impedance.

Bluetooth/UART:

```
void initU2(){
     //U2MODEbits.UARTEN = 1; // UART2 is enabled -- moved to end
28
29
     U2MODEbits.USIDL = 1; // stop in idle mode
     U2MODEbits.IREN = 0; // encoder and decoder disabled
30
    U2MODEbits.RTSMD = 1; // Simplex mode
31
     U2MODEbits.UEN = 0; // enables TX and RX, rest controlled by latches
32
     U2MODEbits.WAKE = 1; // wakeup enabled
33
     U2MODEbits.LPBACK = 0; // disable loopback
3/
35
     U2MODEbits.ABAUD = 0; // disable auto-baud rate
     U2MODEbits.URXINV = 0; // U2RX idle state = 1
36
37
     U2MODEbits.BRGH = 1; // high-speed mode
     U2MODEbits.PDSEL = 0; // 8-bit mode with no parity
38
     U2MODEbits.STSEL = 0; // 1 stop bit
39
40
     U2STAbits.UTXISEL1 = 0;
41
     U2STAbits.UTXISEL0 = 0; // interrupt generated when any character is transferred to the Transmit Shift register
42
     U2STAbits.UTXINV = 0; // U2TX idle state = 1
43
44
     U2STAbits.UTXBRK = 0; // Sync Break disabled
     U2STAbits.URXISEL = 0; // interrupt generated when a character is received
45
46
47
     U2BRG = 90; // sets baud rate = Fcy/4(U2BRG + 1) = 40M/(4*91) ~= 115200
48
     U2MODEbits.UARTEN = 1; // UART2 is enabled
49
     U2STAbits.UTXEN = 1; // transmitter enabled - U2TX and U2RX enabled
50
51
52
     }
```

Figure-47: Initialize the UART

This code initializes the UART module, in this case, U2. This allows us to send a byte of data at a time to the Bluetooth module so that data can be transferred. The most important configuration done here is setting the UART module to use 8-bits with a single stop bit and setting the baud rate to around 115200, which is the value the RN4870 runs at by default

```
54
     void putU2(char c){
         while (U2STAbits.UTXBF) ; //wait if transmission buffer full
55
56
         U2TXREG = c; // write value to transmit FIFO
57
     }
58
59
     char getU2(){
60
         while (!U2STAbits.URXDA) ; // wait till receive buffer has data
         return U2RXREG; // return value of receiver FIFO
61
62
     }
63
     void __attribute__((__interrupt__)) _U2TXInterrupt(void)
64
65
         IFS1bits.U2TXIF = 0; // clear TX interrupt flag
66
67
     }
```

Figure-48: UART Send and Receive

This code allows us to listen to the UART line, as well as write to the UART line.

This is used to send and receive messages via Bluetooth. These methods simply wait until

there is room to send data and sends it or if data has been received, then returns it.

```
int main(void) {
69
         initClockPLL();
70
         IEC1bits.U2TXIE = 1; // Enable UART TX Interrupt
71
72
         initU2();
73
         ms delay(1000); // wait 1 second -- need to wait min of (1/BaudRate)
74
75
         char str[20]; // set aside array
         int i;
76
77
78
         sprintf(str, "TEST");
79
         for(i = 0; i < (4); i++){</pre>
             putU2(str[i]); // write a single char
80
             ms_delay(100); //wait
81
82
         }
83
         while(1){
84
85
         }
86
87
         return 0;
     }
88
```

Figure-49: Main Method

This code is to test the functionality of the UART and Bluetooth modules. It simply initializes the U2 module and the sends the string "TEST" character-by-character to the RN4870, which sends it to the connected devices, i.e. a phone, where the message "TEST" can be received and displayed.

Application Software – Level 1 (KL)



Figure-50: Application Software Block Diagram Level 1

Tab	ble 5.1 – Functional Requirements: Bluetooth Module (Phone)
Module	Bluetooth module (phone)
Designers	Kevin Libertowski
Inputs	Impedance measurements
Outputs	Control signal
Description	This will allow the phone application to communicate with the embedded
	processor. It will be receiving impedance measurements from the
	embedded processor and sending signals to start the measurement.

Та	ble 5.2 – Functional Requirements: Mobile App (Front End)
Module	Mobile App (front end)
Designers	Kevin Libertowski
Inputs	Impedance measurements
Outputs	User and measurement data, control signal
Description	The mobile app front end will be running on the user's phone or tablet. It
	will display the measurements and provide an interface for saving the
	users info and measurements to the cloud. It will provide both current
	and past measurements displayed in text and graph form. This is also
	where the post processing will be done for calculating the user's
	hydration level.

	Table 5.3 – Functional Requirements: Server
Module	Server
Designers	Kevin Libertowski
Inputs	HTTP requests containing user/measurement data
Outputs	HTTP responses containing requested data
Description	The purpose of the server is to provide an interface for our mobile app to
	save and retrieve data from the database. The server will be setup using
	AWS Lambda using the Node.JS runtime. An AWS gateway API will be
	configured to bridge the mobile application with the Lambda functions.

Table 5.4 – Functional Requirements: Database			
Module	Database		
Designers	Kevin Libertowski		
Inputs	SQL queries from server		
Outputs	Stored measurement and user data		
Description	The database will be setup using Amazon RDS for PostgreSQL. The		
	database will save measurement and account data for each individual		
	user. It will allow all previous readings to be retrieved anytime from any		
	mobile device with the user login credentials.		

The application software block diagram shows the different components and data flow for the app. The application software will serve the main purpose of displaying the user's measurements in a user-friendly manner. It will also allow the user to easily view past results and see them plotted over a time period of their choice. The mobile app will also save data to the cloud where it will be able to be accessed across multiple devices.

To accomplish this, the application software will be distributed across several components. To start things off, the phone app will need access to the measurement data. This will happen by sending each measurement to the phone over Bluetooth. For this to work, there will need to be an initial pairing process between the embedded processor and the phone. Once this is done, the phone and embedded processor will be able to send and receive data when in range. The mobile app will consist of all the code running on the phone or tablet itself. It will be built using Flutter, which is a modern cross platform mobile framework developed by Google. This will allow the source code to be compiled to run on both iOS and Android devices.

The mobile app will play a crucial role in the overall user experience. One of the primary functions will be displaying the measurement data to the user. This measurement will include the impedance value and the user's estimated hydration level. The measurement will be displayed automatically when a new measurement is recorded and received by the phone. The user will also be able to view a plot of, past measurements over a time period of their choice.

The server will provide an interface for the mobile app to communicate with the database. It will also handle authentication to ensure that a user can only access data they have permission to use. The server will be implemented using AWS Lambda, with a Node.js runtime. The API end points will be configured using the Amazon API Gateway. Each API endpoint will contain corresponding code and interacts with the database, whether it is adding or retrieving data.

]	Table 6.1 – Us	er Database	SQL Table		
ID	Username	Password	DOB	Height	Weight	Sex
		(encrypted)				

Table 6.2 – Measurement Database SQL Table							
ID	Impedance	Impedance	Frequency	Date	ICW	ECW	User
	(Re)	(Im)					

The database will allow user data to be stored over time. The tables above describe the database scheme. The database will consist of two tables. The user table will

store data specific to each user such as username password and body statistics. The body statistics may be useful for analyzing the impedance. The other table is the measurement table. This has a many-to-one relationship with the user table, as a single user may have many measurements. This table will contain a row for every individual measurement taken. It will store the impedance, date taken, user it was associated with and eventually the approximated intra and extracellular water contents of the user.

Subsystem Code (RB, KL) Mobile App (RB)

```
15 void main() {
16 runApp(MaterialApp(
17 title: 'App',
18 home: MyApp(),
19 ));
20 }
21
22 class MyApp extends StatefulWidget{
23 @override
24 _MyAppState createState() => _MyAppState();
25 }
```

Figure-51: Initiate the App

These two methods determine what happens when the app is launched. The main() methods is what is first run and it tells the phone to run MyApp(), which is what contains the layout and controls for everything in our app.

```
class _MyAppState extends State<MyApp> {
28
      // This widget is the root of your application.
      @override
      Widget build(BuildContext context) {
         return MaterialApp(
           title: 'BioImpedance Tracker',
          theme: ThemeData(
             primarySwatch: Colors.blue,
           ),
           home: Scaffold(
             appBar: AppBar(
               title: Text('BioImpedance Tracker'),
             ),
40
             body: Column(children: <Widget>[
41
               Container(
42
                 alignment: Alignment.center,
                 padding: EdgeInsets.all(20.0),
43
44
                 child: Text(
45
                   'Bioimpedance Tracker App',
                   textAlign: TextAlign.center,
47
                   style: TextStyle(
48
                     fontSize: 25.0,
49
                   ),
                 ),
               ),
               Container(
                 child: Image.asset('assets/body.jpg'),
54
               ),
```

Figure-52: Part I of Login Page	Figure-52	Part 1	of Login	Page
---------------------------------	-----------	--------	----------	------

```
Container(
                 padding: EdgeInsets.all(20.0),
                 child: TextFormField(
                   decoration: InputDecoration(
                     labelText: 'Username',
                   ),
                 ),
               ),
               Container(
                   margin: EdgeInsets.all(50),
                   child: RaisedButton(
                     onPressed: () {
                       Navigator.push(
                         context,
                         MaterialPageRoute(builder: (context) => NavigationPage()),
                       );
                     },
                     child: Text(
                       'Sign In',
                       style: TextStyle(
                         fontSize: 20.0,
                       ),
                     ),
78
                   )),
             ]),
           ),
         );
82
       }
83
     }
```

Figure-53: Part 2 of Login Page

The above two figures make up the first page of the app the users' will see. It has four main parts, each listed as a "container." The first is just a title, giving the name of the app. The second is a picture to describe the app. The third contains a textbox, labeled "username" for a user to access their account. Lastly is a raised button, which would send the information above to the server to verify the user and gather his/her information.



Figure-54: Login Page

The login page would look something like this.

```
class NavigationPage extends StatelessWidget {
85
86
       @override
       Widget build(BuildContext context) {
87
       return Scaffold(
           appBar: AppBar(
89
            title: Text('Navigation Home'),
             //leading: new Container(),
           ),
           body: Column(
94
             children: <Widget>[
              Container(
                 padding: EdgeInsets.all(20.0),
                 child: Row(
98
                   children: <Widget>[
                     Expanded(
                      flex: 3,
                       child: Text(
                         'View Readings',
                         style: TextStyle(
                           fontSize: 20.0,
                         ),
106
                       ),
                     ),
                     Expanded(
                         flex: 1,
                         child: RaisedButton(
                            onPressed: () {
                              Navigator.push(
                                 context,
                                 MaterialPageRoute(builder: (context) => Readings()),
                              );
                             },
```

Figure-55: Part 1 of Navigation Page

117	<pre>shape: StadiumBorder(),</pre>
118	child: Icon(
119	Icons.arrow_right,
120	size: 50.0,
121))),
122],
123),
124),
125	Container(
126	<pre>padding: EdgeInsets.all(20.0),</pre>
127	child: Row(
128	children: <widget>[</widget>
129	Expanded(
130	flex: 3,
131	child: Text(
132	'View Graphs',
133	<pre>style: TextStyle(</pre>
134	fontSize: 20.0,
135),
136),
137),
138	Expanded(
139	flex: 1,
140	child: RaisedButton(
141	onPressed: () {
142	Navigator.push(
143	context,
144	<pre>MaterialPageRoute(builder: (context) => Graphs()),</pre>
145);
146	},

Figure-56: Part 2 of Navigation Page

17	<pre>shape: StadiumBorder(),</pre>
48	child: Icon(
19	Icons.arrow_right,
50	size: 50.0,
51))),
52],
53),
54),
55	Container(
56	<pre>padding: EdgeInsets.all(20.0),</pre>
57	child: Row(
58	children: <widget>[</widget>
59	Expanded(
50	flex: 3,
51	child: Text(
52	'Bluetooth Settings',
53	style: TextStyle(
54	fontSize: 20.0,
55),
56),
57),
58	Expanded(
59	flex: 1,
70	child: RaisedButton(
71	onPressed: () {
72	Navigator.push(
73	context,
74	<pre>MaterialPageRoute(builder: (context) => BluetoothSettings()),</pre>
75);
76	},

Figure-57: Part 3 of Navigation Page



The above for figures make up the navigation page. This creates three titles and a corresponding button for each. Each button leads to a corresponding page, most of which are not final. All three of them have a similar appearance, so I will only show the one with the most progress.



Figure-59: Navigation Page

The overall appearance of the navigation page. More buttons would be added in

the future.

```
static var series = [
       charts.Series<ImpedanceReading,int>(
          domainFn: (ImpedanceReading zData, _) => zData.day,
           measureFn: (ImpedanceReading zData, _) => zData.z,
           colorFn: (_, __) => charts.MaterialPalette.blue.shadeDefault,
           id: 'Impedance',
           data: data,
         ),
       ];
      static var chart = charts.LineChart(
        series,
         animate: true,
         behaviors: [
          new charts.ChartTitle('Day',
             behaviorPosition: charts.BehaviorPosition.bottom,
             titleOutsideJustification: charts.OutsideJustification.middleDrawArea),
         new charts.ChartTitle('Impedance',
             behaviorPosition: charts.BehaviorPosition.start,
             titleOutsideJustification: charts.OutsideJustification.middleDrawArea)
         ],
248
       );
       var chartWidget = Padding(
         padding: EdgeInsets.all(32.0),
        child: SizedBox(
         height: 200.0,
           child: chart,
         ),
       );
```

Figure-60: Part 1 of Graph Page

```
258 @override
259 Widget build(BuildContext context) {
260 return Scaffold(
261 appBar: AppBar(
262 title: Text('Impedance Graphs'),
263 ),
264 body: Column(children: <Widget>[
265 Text("Put graph here"),
266 chartWidget,
267 ],
268 ));
269 }
270 }
```

Figure-61: Part 2 of Graph Page

The above two figures show the code for making the graph page. It consists of

first making the graph widget (currently using test data). It them makes the user page,

which has a title and the graph, and would eventually have some further information.



Figure-62: Graph Page

The above figure shows that a sample graph would look like. We would eventually add more graphs and the ability to pick a time scale.

Finally, I had implemented some code to connect a phone to the Bluetooth module on our Explorer Board, which was the RN4870 Click. This was code in progress and by no means finalized.

```
321 void connectBluetooth() async{
      //make instance
      FlutterBlue bluetooth = FlutterBlue.instance:
    StreamSubscription<ScanResult> scanSub;
327 scanSub = bluetooth.scan().listen((scanResult){
328 if(scanResult.device.name == TARGET_DEVICE_NAME){
         targetDevice = scanResult.device;
330
         connectToDevice(targetDevice);
         bluetooth.stopScan();
        scanSub?.cancel();
         scanSub = null;
       }
     });
     List<BluetoothService> services = await targetDevice.discoverServices();
    services.forEach((service){
        if(service.uuid.toString() == SERVICE_UUID){
          service.characteristics.forEach((characteristic){
           if(characteristic.uuid.toString() == CHAR_UUID){
             targetCharacteristic = characteristic;
              readStream = targetCharacteristic.value;
              targetCharacteristic.setNotifyValue(!targetCharacteristic.isNotifying);
           }
          });
         }
348
      });
349 }
351 connectToDevice(BluetoothDevice targetDevice) async{
352 await targetDevice.connect();
353 }
```

Figure-63: Bluetooth App Code

The above figure shows how we would connect and read data from a phone via Bluetooth. This process would start of on the click of a button. The connection would start by scanning for all Bluetooth devices, and then connect to the target device, in this case, the RN4870. It would then scan that device's services and characteristics, looking for the target message. This message would cause an update to the app and display the data on the "Bluetooth Settings" page shown in the navigation page.

App Server (KL)

The app server would be implemented using AWS Lambda. This service allows API endpoints to be registered to handler functions call Lambda functions. This is called a "serverless" approach since the management of the hardware is handled by AWS and the code is deployed to a virtual server when needed. We would create and implement

various Lambda functions to complete the needs of our application. The pseudocode for

those functions can be found below.

Register User Route:

Get username, password and user's body stats from request body If missing info, return a http status 400 If all info there, hash password and insert row into database users table

Login Route:

Get username and password from http request body Hash password and verify that it matches what is stored in the database If password is incorrect, return a http status code of 403 If password is correct, create JWT that contains user id that will be used for authentication purposes

Get Measurements Route:

Check request for "Authorization" http header If header not found, return an http status of 401 If header found, check that JWT is valid and extract user id from JWT Query database for impedance measurements that belong to this user Return found measurements in http response body

Add Measurement:

Check for authorization (same process as get measurements route) Insert measurement into database table

6 - Mechanical Sketch of System (SW)



Figure-64: Mechanical Sketch (Plan View)

While additional configurations are being considered, Figure-64 shows the current design which is of a "bathroom scale" type of device. This is preferred as it's the most user-friendly and durable option.



Figure-65 shows a cross-section view of the Impedance Monitor device which describes the various systems in the Block Diagrams. Some segments of the system may be combined or separated into more-discrete modules as the design is taken to greater detail.

Figure-66 shows an overall section of the device and the User. This figure shows the approximate scale of the device in comparison to a person, and the approximate signal path through which the bioelectric impedance will be calculated.



Figure-66: Mechanical Sketch (Overall View)

7 – Design Team Information (RB)

- Ryan Byo, Computer Engineering
- Kevin Libertowski, Computer Engineering
- Mitchell Sutyak, Electrical Engineering, No ESI
- Steve Weimer, Electrical Engineering, No ESI

8 – Parts Lists

8.1 – Parts List (SW)
Table 7.1 – Parts List							
Quantity	y Reference Part Number		Description				
1		Explorer 16/32	Embedded Processor Board				
1		dsPIC33FJ256GP710A	High-Frequency Sampling Processor				
1			Bluetooth Module				
1	Rs		Supply Resistor $(1k\Omega)$				
1	U1	TLE2142	Inverting OpAmp				
2	U2, U3	TLE2142	Differential OpAmps				
4	U4-U7	TLE2142	Buffer OpAmps				
1	Rm		Measurement Resistor $(1k\Omega)$				
1	Rb	PTV09A-4020U-B104	Body Potentiometer $(1k-100k\Omega)$				
1	Cb	1266PH-ND	Body Capacitor (200pF)				
1	Vs	9VDC Battery	Power Source for Embedded				
			Processor				
1	V+	(2) 9VDC Batteries	Positive Rail for OpAmps				
1	V-	(2) 9VDC Batteries	Negative Rail for OpAmps				
8	R9-R16		Buffer-Gain Resistors (vary)				
8	R1-R8		Differential-Stage Resistors (vary)				

8.2 – Materials Budget List (SW)

Table 7.2 – Materials Budget List							
Qty	Part NumberDescriptionUt			Total Cost			
			Cost				
1	dsPIC33FJ256GP710A	High-Frequency Sampling	9.67	9.67			
		Processor					
1	TLE2142CP	Inverting OpAmp	4.67	4.67			
1	RN4870 (Click Board)	Bluetooth Module	33.00	33.00			
1	PTV09A-4020U-B104	Body Potentiometer (1k-	0.83	0.83			
		100kΩ)					
1	1266PH-ND	Body Capacitor (200pF)	0.5	0.5			
5	BA9VPC	Battery Holder	2.29	11.45			
2	Prototype Board	Prototype Board (Stock)	n/a	n/a			
2	ST SIP	Single In-Line Solder	n/a	n/a			
		Sockets					
6	TLE2142CP	Low-Noise Diff OpAmps	4.67	28.02			
Total Cost \$88.14							

The materials budget differed from the original materials list and the final materials list. The chief differences from the original materials list were the High-Frequency Sampling Processor and the OpAmps. When implementation was being done, it was determined the embedded processor was incapable of the sampling rate necessary to obtain useful data at high frequency (over 10kHz). The OpAmps were changed multiple times throughout implementation due to issues with low slew-rates and high-noise. The final materials list would have also included items for the device enclosure, sensor pads, etc; due to the unplanned Campus closure, none of the final assembly occurred.

9 – Project Schedule – Proposed Implementation Gantt Chart (MS)

	U	Mode -	Task Name 👻	Duration 👻	Start 👻	Finish 👻	Resource Names +
1		*?	SDP I 2019				
2		*	Project Design	64 days	Fri 8/30/19	Wed 11/27/19	Kevin Libertowski, Mitchell Sutyak, Ryan Byo, Steve Weimer
3 🛉		*	Midterm Report	29 days	Fri 8/30/19	Wed 10/9/19	Kevin Libertowski,Mitchell Sutyak,Ryan Byo,Steve Weimer
4 🛉		*	Cover Page	29 days	Fri 8/30/19	Wed 10/9/19	Kevin Libertowski, Mitchell Sutyak, Ryan Byo, Steve Weimer
5 🛉		*	T of C, L of T, L of F	29 days	Fri 8/30/19	Wed 10/9/19	Kevin Libertowski, Mitchell Sutyak, Ryan Byo, Steve Weimer
6 🛉		*	Problem Statement	29 days	Fri 8/30/19	Wed 10/9/19	Kevin Libertowski, Mitchell Sutyak, Ryan Byo, Steve Weimer
7 🛉		*	Need	29 days	Fri 8/30/19	Wed 10/9/19	Kevin Libertowski, Mitchell Sutyak, Ryan Byo, Steve Weimer
8 🛉		*	Objective	29 days	Fri 8/30/19	Wed 10/9/19	Kevin Libertowski, Mitchell Sutyak, Ryan Byo, Steve Weimer
9 🛉		*	Background	29 days	Fri 8/30/19	Wed 10/9/19	Kevin Libertowski, Mitchell Sutyak, Ryan Byo, Steve Weimer
10 🛉		*	Marketing Requirements	29 days	Fri 8/30/19	Wed 10/9/19	Kevin Libertowski, Mitchell Sutyak, Ryan Byo, Steve Weimer
11 🕴		*	Engineering Requirements Specification	29 days	Fri 8/30/19	Wed 10/9/19	Kevin Libertowski, Mitchell Sutyak, Ryan Byo, Steve Weimer
12 🛉		*	4 Engineering Analysis	29 days	Fri 8/30/19	Wed 10/9/19	Kevin Libertowski, Mitchell Sutyak, Ryan Byo, Steve Weimer
13 🛉		*	- Circuits	29 days	Fri 8/30/19	Wed 10/9/19	Steve Weimer, Mitchell Sutyak
14 🛉		*	Differential Amplifier	29 days	Fri 8/30/19	Wed 10/9/19	Steve Weimer, Mitchell Sutyak
15 🛉		*	Voltage Controlled Current Source	29 days	Fri 8/30/19	Wed 10/9/19	Steve Weimer, Mitchell Sutyak
16 🛉		*	Inverting Amplifier	29 days	Fri 8/30/19	Wed 10/9/19	Steve Weimer, Mitchell Sutyak
17 🕴		*	+ Electronics	29 days	Fri 8/30/19	Wed 10/9/19	Mitchell Sutyak, Steve Weimer
18 🛉		*	Electrode Wiring	29 days	Fri 8/30/19	Wed 10/9/19	Mitchell Sutyak,Steve Weimer
19		*	Signal Processing	29 days	Fri 8/30/19	Wed 10/9/19	Kevin Libertowski. Rvan Bvo
20		*	Topology of Oscillator	29 days	Fri 8/30/19	Wed 10/9/19	Kevin Libertowski.Rvan Byo
21		*	Frequency Sweep	29 days	Fri 8/30/19	Wed 10/9/19	Kevin Libertowski Rvan Bvo
22		*	Square Wave Input	29 days	Fri 8/30/19	Wed 10/9/19	Kevin Libertowski Rvan Bvo
23		*	4 Computer Networks	29 days	Fri 8/30/19	Wed 10/9/19	Kevin Libertowski. Rvan Bvo
24			Wireless Module	20 days	Eri 8/20/19	Wed 10/9/19	Kavin Libertowski Pyan Pyo
25		-	Blusteath	20 days	Fri 8/30/19	Wed 10/9/19	Kevin Libertowski, Nyan Byo
23		-	Same	29 days	Fil 8/30/19	Wed 10/9/19	Kevin Libertowski, Kyan Byo
20		-	Server	29 days	Fri 8/30/19	Wed 10/9/19	Kevin Libertowski, Ryan Byo
21		*	- Psuedo Code	29 days	Fri 8/30/19	wed 10/9/19	Kevin Libertowski, kyan Byo
28		*	Mobile Application	29 days	Fri 8/30/19	Wed 10/9/19	Kevin Libertowski, Ryan Byo
29		*	Hydration Model	29 days	Fri 8/30/19	Wed 10/9/19	Kevin Libertowski,Ryan Byo
30		*	FFT	29 days	Fri 8/30/19	Wed 10/9/19	Kevin Libertowski,Ryan Byo
31 9		*	Signal Generation	29 days	Fri 8/30/19	Wed 10/9/19	Kevin Libertowski,Ryan Byo
32		*	BIA Calculation	29 days	Fri 8/30/19	Wed 10/9/19	Kevin Libertowski,Ryan Byo
33		*	Embedded Systems	29 days	Fri 8/30/19	Wed 10/9/19	Kevin Libertowski, Ryan Byo
34 🛉		*	Embedded Processor	29 days	Fri 8/30/19	Wed 10/9/19	Kevin Libertowski,Ryan Byo
35 🛉		*	Analog to Digital Converter	29 days	Fri 8/30/19	Wed 10/9/19	Kevin Libertowski, Ryan Byo
36 🛉		*	Signal Analysis	29 days	Fri 8/30/19	Wed 10/9/19	Kevin Libertowski,Ryan Byo
37 🛉		*	Transmitter/Receiver	29 days	Fri 8/30/19	Wed 10/9/19	Kevin Libertowski,Ryan Byo
38 🛉		*	User Feedback (LCDs)	29 days	Fri 8/30/19	Wed 10/9/19	Kevin Libertowski,Ryan Byo
39 🛉		*	Accepted Technical Design	29 days	Fri 8/30/19	Wed 10/9/19	Kevin Libertowski, Mitchell Sutyak, Ryan Byo, Steve Weimer
40 🛉		*	Hardware Design: Phase 1	29 days	Fri 8/30/19	Wed 10/9/19	Mitchell Sutyak, Steve Weimer
41 🛉		*	Hardward Block Diagrams Levels 0-N	29 days	Fri 8/30/19	Wed 10/9/19	Mitchell Sutyak, Steve Weimer
42 🛉		*	Software Design: Phase 1	29 days	Fri 8/30/19	Wed 10/9/19	Kevin Libertowski, Ryan Byo
43 🛉		*	Software Behavioral Models Levels 0-N	29 days	Fri 8/30/19	Wed 10/9/19	Kevin Libertowski,Ryan Byo
44 🍦		*	Mechanical Sketch	29 days	Fri 8/30/19	Wed 10/9/19	Steve Weimer
45 🛉		*	Team Information	29 days	Fri 8/30/19	Wed 10/9/19	Kevin Libertowski, Mitchell Sutyak, Ryan Byo, Steve Weimer
46 🛉		*	Project Schedules	29 days	Fri 8/30/19	Wed 10/9/19	Kevin Libertowski, Mitchell Sutyak, Ryan Byo, Steve Weimer
47 🍦		*	Midterm Design Gantt Chart	29 days	Fri 8/30/19	Wed 10/9/19	Kevin Libertowski.Mitchell Sutvak.Rvan Byo.Steve Weimer
48		*	References	29 days	Fri 8/30/19	Wed 10/9/19	Kevin Libertowski Mitchell Sutvak Rvan Bvo Steve Weimer
49		*	Midterm Parts Request Form	32 days	Fri 8/30/19	Mon 10/14/19	Kevin Libertowski.Mitchell Sutyak Ryan Byo Steve Weimer
50		*	Preliminary Design Presentations	0 days	Thu 9/19/19	Thu 9/19/19	Kevin Libertowski Mitchell Sutyak Ryan Byo Steve Weimer
51		*	Project Poster	10 days	Thu 10/10/19	Wed 10/23/19	Kevin Libertowski Mitchell Sutyak Ryan Byo Steve Weimer
52		*	Final Design Report	35 days	Thu 10/10/19	Wed 11/27/19	Kevin Libertowski Mitchell Sutyak Ryan Byo Steve Weiner
53		*	Abract	35 days	Thu 10/10/19	Wed 11/27/10	Kevin Libertowski Mitchell Sutyak Puan Buo Steve Weimer
54		*	Hardware Design: Phare 2	35 days	Thu 10/10/19	Wed 11/27/19	Mitchell Sutvak Steve Weimer
55		•	A Modules 1 . n	25 days	Thu 10/10/19	Wed 11/2//19	Mitchell Sutyak, Steve Weimer
55		*	 Modules 1n 	35 days	Thu 10/10/19	wed 11/2//19	Mitchell Sutyak, Steve Weimer
50		*	Simulations	35 days	Thu 10/10/19	Wed 11/2//19	Mitchell Sutyak,Steve Weimer
57		*	Schematics	35 days	Thu 10/10/19	Wed 11/2//19	Mitchell Sutyak,Steve Weimer
58		* .	Software Design: Phase 2	35 days	Thu 10/10/19	Wed 11/27/19	Kevin Libertowski, Ryan Byo
59		*	 Modules 1n 	35 days	Thu 10/10/19	wed 11/27/19	Kevin Libertowski, Ryan Byo
60		*	Code	35 days	Thu 10/10/19	Wed 11/27/19	Kevin Libertowski,Ryan Byo
61		*	System Integration Behavior Models	35 days	Thu 10/10/19	Wed 11/27/19	Kevin Libertowski,Ryan Byo
62 🛉		* •	Parts Lists	35 days	Thu 10/10/19	Wed 11/27/19	Kevin Libertowski, Mitchell Sutyak, Ryan Byo, Steve Weimer
63		*	Parts List(s) for Schematics	35 days	Thu 10/10/19	Wed 11/27/19	Kevin Libertowski, Mitchell Sutyak, Ryan Byo, Steve Weimer
64 🛉		*	Materials Budget List	35 days	Thu 10/10/19	Wed 11/27/19	Kevin Libertowski, Mitchell Sutyak, Ryan Byo, Steve Weimer
65 🛉		*	Proposed Implementation Gantt Chart	35 days	Thu 10/10/19	Wed 11/27/19	Kevin Libertowski, Mitchell Sutyak, Ryan Byo, Steve Weimer
66 🛉		*	Conclusions and Recommendations	35 days	Thu 10/10/19	Wed 11/27/19	Kevin Libertowski, Mitchell Sutyak, Ryan Byo, Steve Weimer
67 🛉		*	Final Parts Request Form	13 days	Thu 10/10/19	Mon 10/28/19	Kevin Libertowski, Mitchell Sutyak, Ryan Byo, Steve Weimer
68		*	Final Design Presentations Part 1	0 days	Thu 11/14/19	Thu 11/14/19	Kevin Libertowski, Mitchell Sutyak, Ryan Byo, Steve Weimer
69		*	Final Design Presentations Part 2	0 days	Thu 11/21/19	Thu 11/21/19	Kevin Libertowski, Mitchell Sutyak, Ryan Byo, Steve Weimer
					T		

Figure-67: Original Gantt Chart

	0	Task	Tark Nama	Duration	- Start	- Finish	- Predecerrors	Paroura Namar
1	-	Mode *	SDPII Implementation 2020	103 days	Mon 1/13/20	Fri 4/24/20	• Freuecessors •	Resource Names
2		*	Revise Gantt Chart	14 days	Mon 1/13/20	Sun 1/26/20		Mitchell Sutvak
3		+	+ Implement Project Design	96 days	Mon 1/13/20	Fri 4/17/20		Kevin Libertowski, Mitchell Sutvak, Rvan Bvo, Steve Weimer
4		+	+ Hardware Implementation	49 days	Mon 1/13/20	Sun 3/1/20		Mitchell Sutvak, Steve Weimer
5		*	4 Validate Circuit	7 days	Thu 1/30/20	Wed 2/5/20		Mitchell Sutvak Steve Weimer
6		+	Add in LT1079	7 days	Thu 1/30/20	Wed 2/5/20		Mitchell Sutvak Steve Weimer
7		*	Check performance band	7 days	Thu 1/30/20	Wed 2/5/20		Mitchell Sutvak.Steve Weimer
8		*	- Get Power Supply Working	7 days	Thu 2/6/20	Wed 2/12/20		Mitchell Sutvak Steve Weimer
9		*	Differential/single end inputs	7 days	Thu 2/6/20	Wed 2/12/20		Mitchell Sutvak.Steve Weimer
10		*	Battery regulator	7 days	Thu 2/6/20	Wed 2/12/20		Mitchell Sutvak Steve Weimer
11		*	Build Gain Stage for Amplification and Attenuation	7 days	Thu 2/13/20	Wed 2/19/20		Mitchell Sutvak Steve Weimer
12		*	 Midterm Demonstration and Troubleshooting 	7 days	Thu 2/20/20	Wed 2/26/20		Mitchell Sutyak, Steve Weimer
13		*	Functioning BIA with circuit/embedded integration	7 days	Thu 2/20/20	Wed 2/26/20		Mitchell Sutyak, Steve Weimer
14		*	Solder Board & Socket Strips for DIP's	7 days	Thu 2/27/20	Wed 3/4/20		Mitchell Sutyak,Steve Weimer
15		*	Finsh Soldering and Validate Circuit	7 days	Thu 3/5/20	Wed 3/11/20		Mitchell Sutyak,Steve Weimer
16		*	EagleCAD & PCB Schematic	7 days	Thu 3/12/20	Wed 3/18/20		Mitchell Sutyak,Steve Weimer
17	•	*	Finish PCB & Order	7 days	Thu 3/19/20	Wed 3/25/20		Mitchell Sutyak,Steve Weimer
18	•	*	Validate PCB and Integrate with Embedded	7 days	Thu 3/26/20	Wed 4/1/20		Mitchell Sutyak,Steve Weimer
19	•	*	Mount Hardware onto Acrylic Platform	7 days	Thu 4/2/20	Wed 4/8/20		Mitchell Sutyak,Steve Weimer
20	•	*	Final Validation of all Hardware	7 days	Thu 4/9/20	Wed 4/15/20		Mitchell Sutyak, Steve Weimer
21	•	*	Prep for Demo	7 days	Thu 4/16/20	Wed 4/22/20		Mitchell Sutyak,Steve Weimer
22	•	*	Final Report	7 days	Thu 4/23/20	Wed 4/29/20		Mitchell Sutyak,Steve Weimer
23	•	*	 Software Implementation 	49 days	Mon 1/13/20	Sun 3/1/20		Kevin Libertowski, Ryan Byo
24		*	 Verify AD/DMA and LCD Code 	7 days	Thu 1/30/20	Wed 2/5/20		Rvan Bvo
25		*	Clean up code, add comments, break down	7 days	Thu 1/30/20	Wed 2/5/20		Ryan Byo
26		*	Start/stop measurements with button	7 days	Thu 1/30/20	Wed 2/5/20		Ryan Byo
27		*	Variably control sample rate	7 days	Thu 1/30/20	Wed 2/5/20		Kevin Libertowski
28		*	Test with RC circuit	7 days	Thu 1/30/20	Wed 2/5/20		Kevin Libertowski
29	•	*	Generate Square Wave Voltage	7 days	Thu 2/6/20	Wed 2/12/20		Kevin Libertowski
30	•	*	Variably change generated sqaure wave frequency	7 days	Thu 2/6/20	Wed 2/12/20		Kevin Libertowski
31	•	*	Communicate to bluetooth module with UART	7 days	Thu 2/6/20	Wed 2/12/20		Ryan Byo
32	•	*	Tie Square Wave and AD Frequency Together	7 days	Thu 2/13/20	Wed 2/19/20		Kevin Libertowski
33	•	*	Create routine for stepping through each frequency	7 days	Thu 2/13/20	Wed 2/19/20		Kevin Libertowski
34	•	*	Display frequency while measuring	7 days	Thu 2/13/20	Wed 2/19/20		Kevin Libertowski
35	•	*	Display impedance after all measured	7 days	Thu 2/13/20	Wed 2/19/20		Kevin Libertowski
36	•	*	Connect Bluetooth to mobile device	7 days	Thu 2/13/20	Wed 2/19/20		Ryan Byo
37	•	*	Send data package to phone	7 days	Thu 2/13/20	Wed 2/19/20		Ryan Byo
38	•	*	Integrate and Test Embedded System with Hardware	7 days	Thu 2/20/20	Wed 2/26/20		Kevin Libertowski, Ryan Byo
39	•	*	Prep for demo	7 days	Thu 2/20/20	Wed 2/26/20		Kevin Libertowski,Ryan Byo
40	•	*	Setup Mobile Application Front End	7 days	Thu 2/27/20	Wed 3/4/20		Ryan Byo
41	•	*	Setup back end (Server and DB)	7 days	Thu 2/27/20	Wed 3/4/20		Kevin Libertowski
42	•	*	Send Impedance Measurements to Phone	7 days	Thu 3/5/20	Wed 3/11/20		Kevin Libertowski
43		*	Receive Bluetooth message	7 days	Thu 3/5/20	Wed 3/11/20		Ryan Byo
44	•	*	Display impedance to user	7 days	Thu 3/5/20	Wed 3/11/20		Ryan Byo
45	•	*	Save Measurements to DB	7 days	Thu 3/12/20	Wed 3/18/20		Kevin Libertowski
46	•	*	Retreive measurements from DB	7 days	Thu 3/12/20	Wed 3/18/20		Kevin Libertowski
47	•	*	Display history of measurements to user with graphs	7 days	Thu 3/12/20	Wed 3/18/20		Ryan Byo
48	•	*	User Account Info and Sign In Forms	7 days	Thu 3/19/20	Wed 3/25/20		Ryan Byo
.49	•	*	Save and retrieve user information from DB	7 days	Thu 3/19/20	Wed 3/25/20		Kevin Libertowski
50	•	*	Finish Mobile App	7 days	Thu 3/26/20	Wed 4/1/20		Kevin Libertowski,Ryan Byo
51	•	*	Post Processing - Hydration Calculations	7 days	Thu 4/2/20	Wed 4/8/20		Kevin Libertowski,Ryan Byo
52	•	*	Final System Integration and Debugging	7 days	Thu 4/9/20	Wed 4/15/20		Kevin Libertowski,Ryan Byo
53	•	*	Preparation for Demo	7 days	Thu 4/16/20	Wed 4/22/20		Kevin Libertowski,Ryan Byo
54	•	*	Final Report	7 days	Thu 4/23/20	Wed 4/29/20		Kevin Libertowski,Ryan Byo
55	•	*	Develop Final Report	103 days	Mon 1/13/20	Fri 4/24/20		Kevin Libertowski, Mitchell Sutyak, Ryan Byo, Steve Weimer
56	•	*	Write Final Report	103 days	Mon 1/13/20	Fri 4/24/20		Kevin Libertowski, Mitchell Sutyak, Ryan Byo, Steve Weimer
57		-	Submit Final Report	0 days	Fri 4/24/20	Fri 4/24/20	56	Kevin Libertowski, Mitchell Sutyak, Ryan Byo, Steve Weimer
58	•	*	Spring Recess	7 days	Mon 3/23/20	Sun 3/29/20		Kevin Libertowski, Mitchell Sutyak, Ryan Byo, Steve Weimer
59		*	Project Demonstration and Presentation	0 days	Mon 4/20/20	Mon 4/20/20		Kevin Libertowski, Mitchell Sutyak, Ryan Byo, Steve Weimer

Figure-68: Final Gantt Chart

The changes to the original and final Gantt Charts differ based on what was originally planned to be accomplished compared to what needed to be accomplished. At one point there was a plan to use a printed circuit board through EagleCAD, however, with a lack of time and availability of PCB's to be shipped, the final design was going to be soldered onto a protoboard. With regards to the hardware side of the project, figuring out which OpAmp to use ended up being the key to making the design work. Like the original Gantt Chart, in the final semester the same blocks of hardware were used - inverting, VCCS, differentials - in order to obtain useable data. With regards to the electrodes, a simpler approach was going to be used by using two plates that the user would step onto in order to make the connection. This differed from the original idea of using electrodes that would be built into a scale like device.

10 – Conclusions and Recommendations (KL & SW)

These past semesters we have demonstrated the theory behind this project and have implemented many of the subsystems it consists of. We have designed and simulated the circuits required to send and analyze a signal through the body. We have implemented algorithms to calculate the impedance based on discrete samples of the input and output voltage and current waveforms. We have constructed and validated a breadboard circuit which closely matches the simulated Bioimpedance circuit. And we have demonstrated the ability to be able to sample analog signals using the embedded processor and output to the LCD of the Explorer board.

The next steps in this project – if the Spring Semester had not been interrupted due to the Campus Shutdown – would have been to finish integrating all of the subsystems, validate the overall combined system, and constructed an enclosure package for the user to interface with the device. While most subsystems were merely a matter of proper implementation, we recommend special attention be given to OpAmp selection; to construct a circuit of this type it was necessary to use fast (high slew-rate), low-noise OpAmps to achieve useful data.

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11 - References

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[14] "Worker Deaths by Electrocution: A summary of NIOSH Surveillance and Investigative Findings", US Department of Health and Human Services, May 1998. (SW)

12 – Appendices

- 1. PIC24FJ1024GB610 Data Sheet http://ww1.microchip.com/downloads/en/DeviceDoc/PIC24FJ1024GA610-GB610-Family-Data-Sheet-DS30010074F.pdf
- 2. PIC24FJ1024GB610 Data Sheet http://ww1.microchip.com/downloads/en/DeviceDoc/70286C.pdf
- 3. Explorer 16/32 Development Board User's Guide https://microchipdeveloper.com/boards:explorer1632
- 4. UA741 Data Sheet http://www.ti.com/lit/ds/slos094g/slos094g.pdf
- 5. LM318 Data Sheet http://www.ti.com/lit/ds/symlink/lm134.pdf
- 6. TLE2142 Data Sheet http://www.ti.com/lit/ds/slos628/slos628.pdf